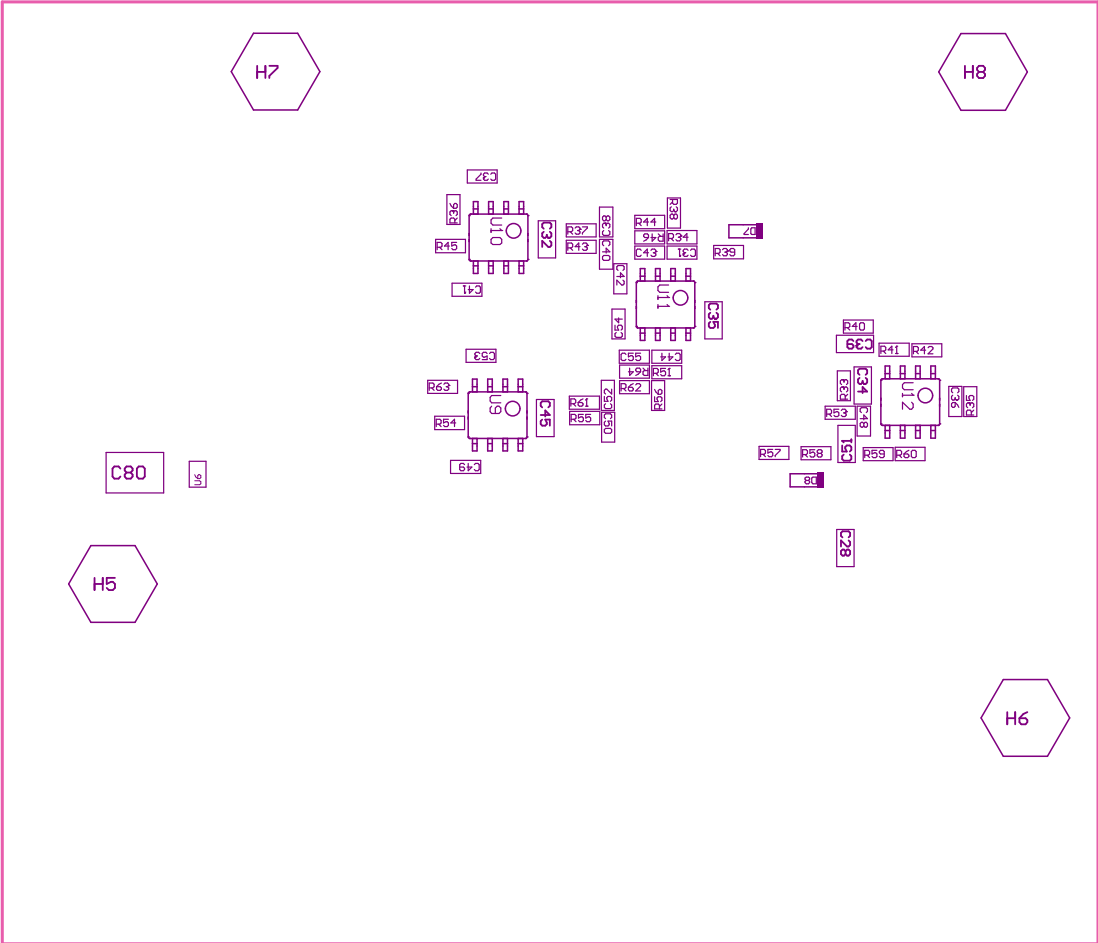


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 12/10/2015 2:12:53 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00202	REV: Rev E1	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/10/2015 2:12:55 PM	TEXAS INSTRUMENTS	

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